

NRTS660MFD, NRVTS660MFD

Very Low Forward Voltage Trench-based Schottky Rectifier

This trench Schottky rectifier in the dual flag SO-8 flat lead package offers designers a unique degree of versatility and design freedom. The two devices are electrically independent and can be used separately, as common cathode, as common anode or in series as a function of board level layout. The exposed pad design provides low thermal resistance. The clip attach design creates a package with very efficient die size to board area ratio. While thermal performance is nearly the same as the DPAK package height and board footprint are less than half.

Trench Schottky technology provides a superior forward voltage/leakage tradeoff compared to planar Schottky. The reverse switching characteristics are extremely stable over temperature minimizing switching power loss in high frequency applications.

Features

- New Package Provides Capability of Inspection and Probe After Board Mounting
- Low Forward Voltage Drop
- 175°C Operating Junction Temperature
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free and Halide-Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

Applications

- Excellent Alternative to DPAK in Space-Constrained Automotive Applications
- Output Rectification in Switching Power Supplies
- Freewheeling Diode used with Inductive Loads
- Automotive LED Lighting (Interior and Exterior)



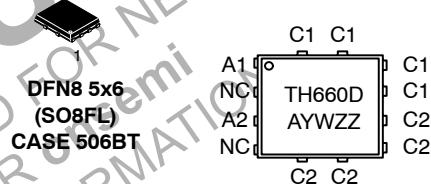
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TRENCH SCHOTTKY RECTIFIER 6 AMPERES (3x2), 60 VOLTS



MARKING DIAGRAM



TH660D = Specific Device Code
A = Assembly Location
Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping†
NRTS660MFDT1G	DFN8 (Pb-Free)	1500 / Tape & Reel
NRTS660MFDT3G	DFN8 (Pb-Free)	5000 / Tape & Reel
NRVTS660MFDT1G	DFN8 (Pb-Free)	1500 / Tape & Reel
NRVTS660MFDT3G	DFN8 (Pb-Free)	5000 / Tape & Reel
NRVTS660MFDWT3G	DFN8 (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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MAXIMUM RATINGS (per diode unless noted)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R	60	
Average Rectified Forward Current (Rated V_R , $T_C = 173^\circ\text{C}$)	$I_{F(AV)}$	3.0	A
Peak Repetitive Forward Current, (Rated V_R , Square Wave, 20 kHz, $T_C = 172^\circ\text{C}$)	I_{FRM}	6.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I_{FSM}	80	A
Storage Temperature Range	T_{stg}	-65 to +175	$^\circ\text{C}$
Operating Junction Temperature	T_J	-55 to +175	$^\circ\text{C}$
Unclamped Inductive Switching Energy (10 mH Inductor, Non-repetitive)	E_{AS}	10	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS (per diode unless noted)

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance, Junction-to-Lead, Steady State (Assumes 650 mm ² 1 oz. copper bond pad, on a FR4 board)	ψ_{JCL}	-	2.1	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient, Steady State (Assumes 650 mm ² 1 oz. copper bond pad, on a FR4 board)	$R_{\theta JA}$	-	59	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS (per diode unless noted)

Instantaneous Forward Voltage (Note 1) ($i_F = 3.0$ Amps, $T_J = 125^\circ\text{C}$) ($i_F = 3.0$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 6.0$ Amps, $T_J = 125^\circ\text{C}$) ($i_F = 6.0$ Amps, $T_J = 25^\circ\text{C}$)	V_F	0.41 0.48 0.52 0.55	0.56 0.63 0.72 0.75	V
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 125^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	3.0 6.2	8 55	mA μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

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TYPICAL CHARACTERISTICS

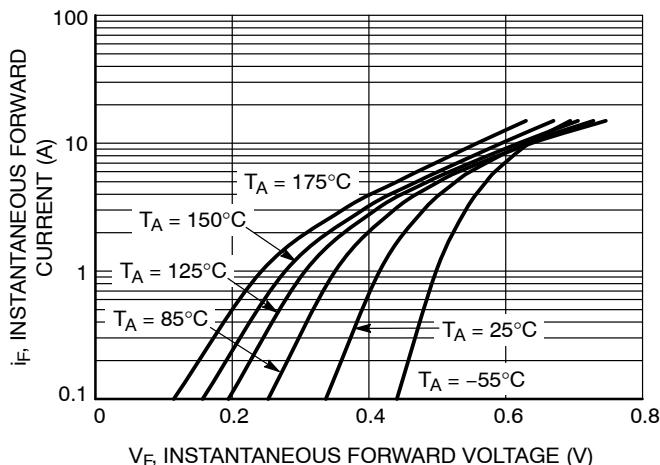


Figure 1. Typical Instantaneous Forward Characteristics

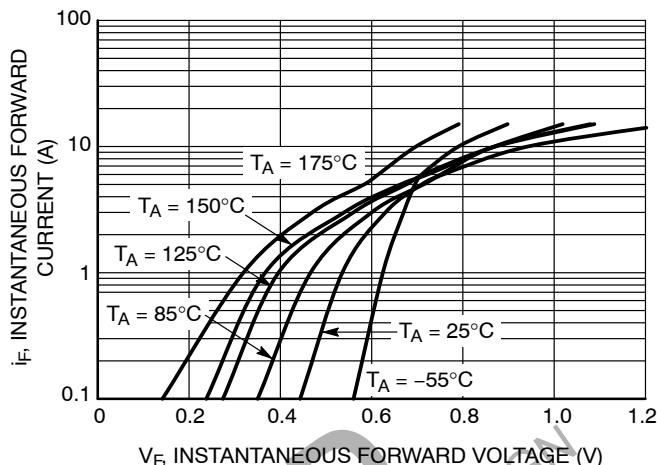


Figure 2. Maximum Instantaneous Forward Characteristics

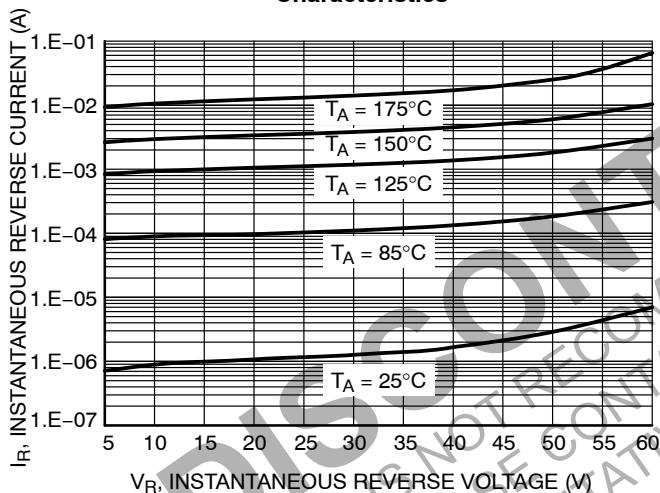


Figure 3. Typical Reverse Characteristics

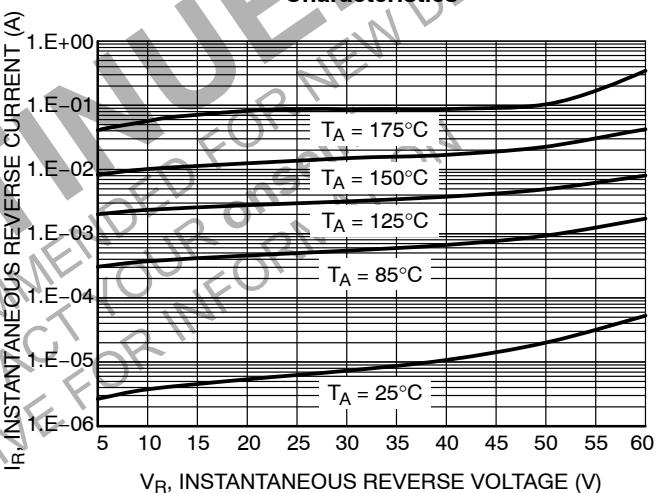


Figure 4. Maximum Reverse Characteristics

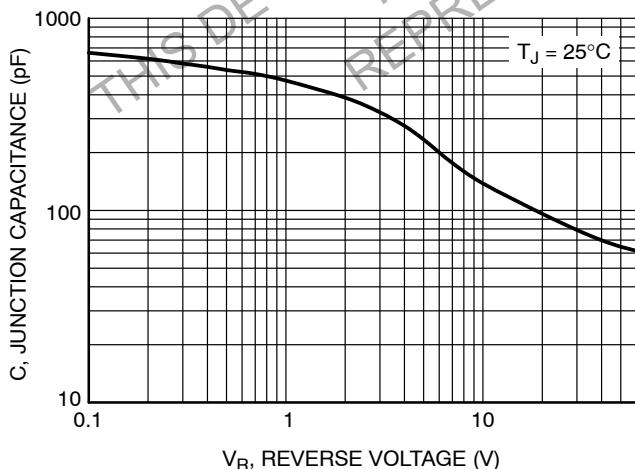


Figure 5. Typical Junction Capacitance

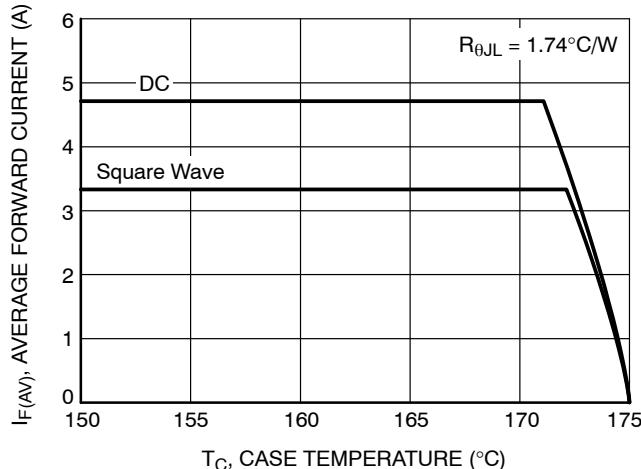
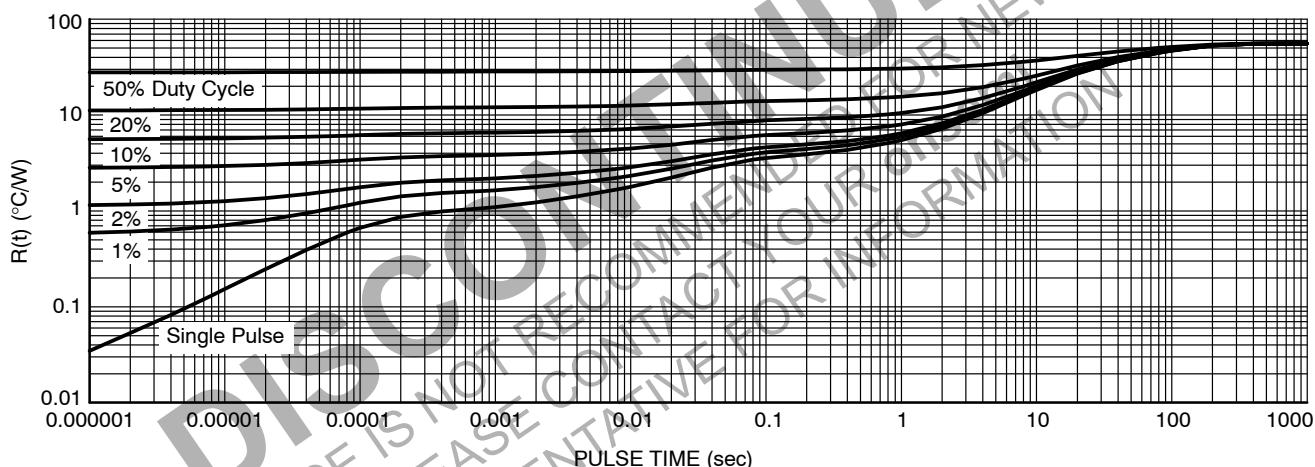
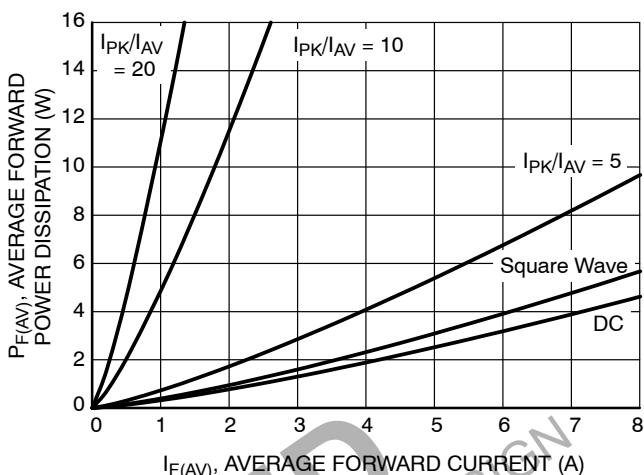
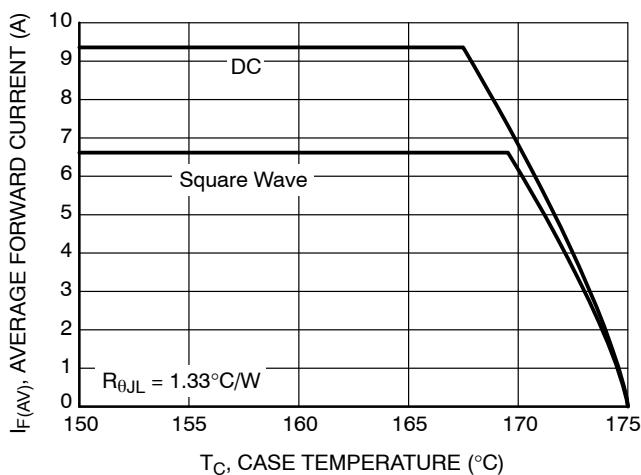


Figure 6. Current Derating, Per Diode

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TYPICAL CHARACTERISTICS



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